

#### **General Description**

The MAX7301 compact, serial-interfaced I/O expander (or general-purpose I/O (GPIO) peripheral) provides microprocessors with up to 28 ports. Each port is individually user configurable to either a logic input or logic output.

Each port can be configured either as a push-pull logic output capable of sinking 10mA and sourcing 4.5mA, or a Schmitt logic input with optional internal pullup. Seven ports feature configurable transition detection logic, which generates an interrupt upon change of port logic level. The MAX7301 is controlled through an SPI™-compatible 4-wire serial interface.

The MAX7301AAX and MAX7301ATL have 28 ports and are available in 36-pin SSOP and 40-pin TQFN packages, respectively. The MAX7301AAI has 20 ports and is available in a 28-pin SSOP package.

For a 2-wire I<sup>2</sup>C-interfaced version, refer to the MAX7300 data sheet.

For a pin-compatible port expander with additional 24mA constant-current LED drive capability, refer to the MAX6957 data sheet.

### **Applications**

White Goods Automotive **Gaming Machines** Industrial Controllerss System Monitoring

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Pin Configurations appear at end of data sheet.

### Features

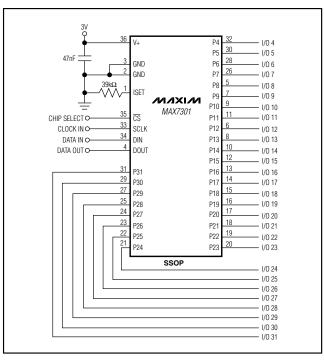
- ♦ High-Speed 26MHz SPI-/QSPI-TM/MICROWIRETM-**Compatible Serial Interface**
- ♦ 2.5V to 5.5V Operation
- ♦ -40°C to +125°C Temperature Range
- ♦ 20 or 28 I/O Ports, Each Configurable as **Push-Pull Logic Output** Schmitt Logic Input Schmitt Logic Input with Internal Pullup
- ♦ 11µA (max) Shutdown Current
- ♦ Logic Transition Detection for Seven I/O Ports

### **Ordering Information**

PART	TEMP RANGE	PIN- PACKAGE	PKG CODE
MAX7301AAI+	-40°C to +125°C	28 SSOP	A28-1
MAX7301AAX+	-40°C to +125°C	36 SSOP	A36-4
MAX7301ATL+	-40°C to +125°C	40 TQFN	T4066-5

<sup>+</sup>Denotes lead-free package.

### **Typical Operating Circuit**



MIXIM

Maxim Integrated Products 1

#### **ABSOLUTE MAXIMUM RATINGS**

(Voltage with respect to GND.) V+0.3V to +6V	36-Pin SSOP (derate 11.8mW/°C above +70°C)941mW 40-Pin TQFN (derate 26.3mW/°C above +70°C)2963.0mW
All Other Pins0.3V to $(V+ + 0.3V)$ P4–P31 Current±30mA GND Current800mA Continuous Power Dissipation $(T_A = +70^{\circ}C)$ 28-Pin SSOP (derate 9.5mW/°C above +70°C)762mW	Operating Temperature Range (T <sub>MIN</sub> , T <sub>MAX</sub> )40°C to +125°C Junction Temperature+150°C Storage Temperature Range65°C to +150°C Lead Temperature (soldering, 10s)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS**

(Typical Operating Circuit, V+ = 2.5V to 5.5V,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDI	TIONS	MIN	TYP	MAX	UNITS	
Operating Supply Voltage	V+			2.5		5.5	V	
		All districtions at a state	$T_A = +25^{\circ}C$		5.5	8		
Shutdown Supply Current	ISHDN	All digital inputs at V+ or GND	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$			10	μΑ	
		o. d. 12	$T_A = T_{MIN}$ to $T_{MAX}$			11		
		All ports programmed	T <sub>A</sub> = +25°C		180	230		
Operating Supply Current (Output High)	IGPOH	as outputs high, no load, all other inputs	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$			250	μΑ	
(		at V+ or GND	$T_A = T_{MIN}$ to $T_{MAX}$			270		
	All ports programmed $T_A = +25^{\circ}\text{C}$		$T_A = +25^{\circ}C$		170	210		
Operating Supply Current (Output Low)	IGPOL	as outputs low, no load, all other inputs	$T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$			230	μΑ	
(Odiput Low)		at V+ or GND  TA = T <sub>MIN</sub> to T <sub>M</sub>				240		
		All ports programmed as inputs without	T <sub>A</sub> = +25°C		110	135		
Operating Supply Current (Input)	IGPI	pullup, ports, and all	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			140	μΑ	
		other inputs at V+ or GND	$T_A = T_{MIN}$ to $T_{MAX}$			145		
INPUTS AND OUTPUTS								
Logic High Input Voltage Port Inputs	VIH			0.7 × V+			V	
Logic Low Input Voltage Port Inputs	VIL					0.3 × V+	V	
Input Leakage Current	I <sub>IH</sub> , I <sub>IL</sub>	GPIO inputs without pu VPORT = V+ to GND	llup,	-100	±1	+100	nA	
CDIO Inc. it Internal Dullium to V.	1=	V+ = 2.5V		12	19	30		
GPIO Input Internal Pullup to V+	I <sub>PU</sub>	V+ = 5.5V		80	120	180	μΑ	
Hysteresis Voltage GPIO Inputs	ΔVI				0.3		V	
Output High Voltage	Vari	GPIO outputs, ISOURCE $T_A = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	V+ - 0.7			V		
Output High Voltage	Voн	GPIO outputs, ISOURCE TA = T <sub>MIN</sub> to T <sub>MAX</sub> (Not		V+ - 0.7			V	

### **ELECTRICAL CHARACTERISTICS (continued)**

(Typical Operating Circuit, V+ = 2.5V to 5.5V,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Port Sink Current	loL	$V_{PORT} = 0.6V$	2	10	18	mA
Output Short-Circuit Current	lolsc	Port configured output low, shorted to V+	2.75	11	20.00	mA
Input High-Voltage SCLK, DIN,	\/	V+ ≤ 3.3V	1.6			V
CS	V <sub>IH</sub>	V+ > 3.3V	2			V
Input Low-Voltage SCLK, DIN, CS	VIL				0.6	V
Input Leakage Current SCLK, DIN, CS	I <sub>IH</sub> , I <sub>IL</sub>		-50		+50	nA
Output High-Voltage DOUT	V <sub>OH</sub>	ISOURCE = 1.6mA	V+ - 0.5			V
Output Low-Voltage DOUT	V <sub>OL</sub>	ISINK = 1.6mA			0.4	V

#### **TIMING CHARACTERISTICS (Figure 3)**

(V+ = 2.5V to 5.5V,  $T_A = T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.) (Note 1)

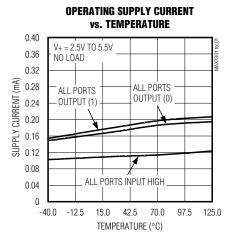
PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
CLK Clock Period	tCP		38.4			ns
CLK Pulse Width High	tCH		19			ns
CLK Pulse Width Low	t <sub>CL</sub>		19			ns
CS Fall to SCLK Rise Setup Time	tcss		9.5			ns
CLK Rise to CS Rise Hold Time	tcsh		0			ns
DIN Setup Time	t <sub>DS</sub>		9.5			ns
DIN Hold Time	tDH		0			ns
Output Data Propagation Delay	tDO	C <sub>LOAD</sub> = 25pF			21	ns
Minimum CS Pulse High	tcsw		19			ns

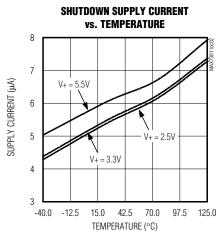
**Note 1:** All parameters tested at  $T_A = +25^{\circ}C$ . Specifications over temperature are guaranteed by design.

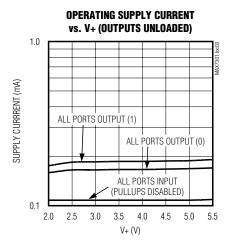
Note 2: Guaranteed by design.

### **Typical Operating Characteristics**

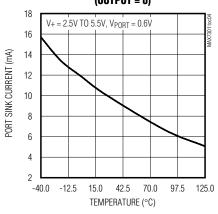
 $(T_A = +25^{\circ}C, \text{ unless otherwise noted.})$ 



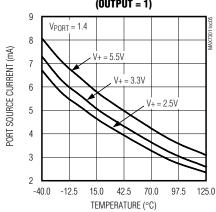




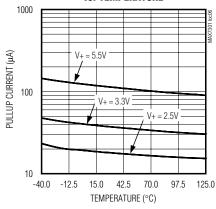
GPO SINK CURRENT vs. TEMPERATURE (OUTPUT = 0)



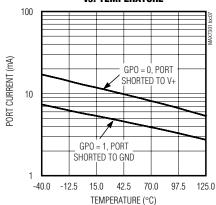




## GPI PULLUP CURRENT vs. TEMPERATURE



## GPO SHORT-CIRCUIT CURRENT vs. TEMPERATURE



#### **Pin Description**

	PIN			FUNCTION
36 SSOP	28 SSOP	TQFN	NAME	FUNCTION
1	1	36	ISET	Bias Current Setting. Connect ISET to GND through a resistor (RISET) value of 39k $\Omega$ to 120k $\Omega$ .
2, 3	2, 3	37, 38, 39	GND	Ground
4	4	40	DOUT	4-Wire Interface Serial Data Output Port
_	5–24	_	P12-P31	I/O Ports. P12 to P31 can be configured as push-pull outputs, CMOS logic inputs, or CMOS logic inputs with weak pullup resistor.
5–32	_	1–10, 12–19, 21–30	P4-P31	I/O Ports. P4 to P31 can be configured as push-pull outputs, CMOS logic inputs, or CMOS logic inputs with weak pullup resistor.
_	_	11, 20, 31	N.C.	No Connection. Not internally connected.
33	25	32	SCLK	4-Wire Interface Serial Clock Input Port
34	26	33	DIN	4-Wire Interface Serial Data Input Port
35	27	34	<u>CS</u>	4-Wire Interface Chip-Select Input, Active Low
36	28	35	V+	Positive Supply Voltage. Bypass V+ to GND with a minimum 0.047µF
_	_	PAD	Exposed Pad	Exposed Pad on Package Underside. Connect to GND.

### **Detailed Description**

The MAX7301 GPIO peripheral provides up to 28 I/O ports, P4 to P31, controlled through an SPI-compatible serial interface. The ports can be configured to any combination of logic inputs and logic outputs, and default to logic inputs on power-up.

Figure 1 is the MAX7301 functional diagram. Any I/O port can be configured as a push-pull output (sinking 10mA, sourcing 4.5mA), or a Schmitt-trigger logic input. Each input has an individually selectable internal pullup resistor. Additionally, transition detection allows seven ports (P24 through P30) to be monitored in any maskable combination for changes in their logic status. A detected transition is flagged through an interrupt pin (port P31).

The port configuration registers set the 28 ports, P4 to P31, individually as GPIO. A pair of bits in registers 0x09 through 0x0F sets each port's configuration (Tables 1 and 2).

The 36-pin MAX7301AAX and 40-pin MAX7301ATL have 28 ports, P4 to P31. The 28-pin MAX7301AAI is offered in 20 ports, P12 to P31. The eight unused ports should be configured as outputs on power-up by writing 0x55 to registers 0x09 and 0x0A. If this is not done, the eight unused ports remain as floating inputs and

quiescent supply current rises, although there is no damage to the part.

#### Register Control of I/O Ports Across Multiple Drivers

The MAX7301 offers 20 or 28 I/O ports, depending on package choice.

Two addressing methods are available. Any single port (bit) can be written (set/cleared) at once; or, any sequence of eight ports can be written (set/cleared) in any combination at once. There are no boundaries; it is equally acceptable to write P0 through P7, P1 through P8, or P31 through P38 (P32 through P38 are nonexistent, so the instructions to these bits are ignored).

#### Shutdown

When the MAX7301 is in shutdown mode, all ports are forced to inputs (which can be read), and the pullup current sources are turned off. Data in the port and control registers remain unaltered so port configuration and output levels are restored when the MAX7301 is taken out of shutdown. The display driver can still be programmed while in shutdown mode. For minimum supply current in shutdown mode, logic inputs should be at GND or V+ potential. Shutdown mode is exited by setting the S bit in the configuration register (Table 6).

Table 1. Port Configuration Map

REGISTER	ADDRESS	REGISTER DATA											
nEGISTEN	CODE (HEX)	D7	D6	D5	D4	D3	D2	D1	D0				
Port Configuration for P7, P6, P5, P4	0x09	P7		P	6	P5		F	P4				
Port Configuration for P11, P10, P9, P8	0x0A	P1	P11		P10		P10		P10 P9		9 P8		28
Port Configuration for P15, P14, P13, P12	0x0B	P1	P15		P14		P14 P13		13	P12			
Port Configuration for P19, P18, P17, P16	0x0C	P1	19	P18		P17		P17 P					
Port Configuration for P23, P22, P21, P20	0x0D	P2	P23		P22		P22 P2		21 P		20		
Port Configuration for P27, P26, P25, P24	0x0E	P27		P27 P26		P26 P25		25	P	24			
Port Configuration for P31, P30, P29, P28	0x0F	P31		P30		P30 P29		P	28				

**Table 2. Port Configuration Matrix** 

MODE	FUNCTION	PORT REGISTER (0x20–0x5F)	PIN BEHAVIOR	ADDRESS CODE (HEX)	PORT CONFIGURATION BIT PAIR		
	(0xA0-0xDF)			, , ,	UPPER	LOWER	
	DO N	OT USE THIS SETT	ING	0x09 to 0x0F	0	0	
Output	GPIO Output	Register bit = 0	Active-low logic output	0x09 to 0x0F	0	4	
Output	GFIO Output	Register bit = 1	Active-high logic output	0009 10 000	O	I	
Input	GPIO Input Without Pullup	Register bit =	Schmitt logic input	0x09 to 0x0F	1	0	
Input	GPIO Input with Pullup	input logic level	Schmitt logic input with pullup	0x09 to 0x0F	1	1	

#### Serial Interface

The MAX7301 communicates through an SPI-compatible 4-wire serial interface. The interface has three inputs, Clock (SCLK), Chip Select ( $\overline{CS}$ ), and Data In (DIN), and one output, Data Out (DOUT).  $\overline{CS}$  must be low to clock data into or out of the device, and DIN must be stable when sampled on the rising edge of SCLK. DOUT provides a copy of the bit that was input 15.5 clocks earlier, or upon a query it outputs internal register data, and is stable on the rising edge of SCLK. Note that the SPI protocol expects DOUT to be high impedance when the MAX7301 is not being accessed; DOUT on the MAX7301 is never high impedance. See www.maxim-ic.com/an 1879 for ways to convert DOUT to tri-state, if required.

SCLK and DIN may be used to transmit data to other peripherals, so the MAX7301 ignores all activity on SCLK and DIN except between the fall and subsequent rise of  $\overline{\text{CS}}$ .

# Control and Operation Using the 4-Wire Interface

Controlling the MAX7301 requires sending a 16-bit word. The first byte, D15 through D8, is the command

address (Table 3), and the second byte, D7 through D0, is the data byte (Table 4 through Table 8).

# Connecting Multiple MAX7301s to the 4-Wire Bus

Multiple MAX7301s may be daisy-chained by connecting the DOUT of one device to the DIN of the next, and driving SCLK and  $\overline{\text{CS}}$  lines in parallel (Figure 3). Data at DIN propagates through the internal shift registers and appears at DOUT 15.5 clock cycles later, clocked out on the falling edge of SCLK. When sending commands to multiple MAX7301s, all devices are accessed at the same time. An access requires (16  $\times$  n) clock cycles, where n is the number of MAX7301s connected together. To update just one device in a daisy-chain, the user can send the No-Op command (0x00) to the others.

#### **Writing Device Registers**

The MAX7301 contains a 16-bit shift register into which DIN data are clocked on the rising edge of SCLK, when  $\overline{CS}$  is low. When  $\overline{CS}$  is high, transitions on SCLK have no effect. When  $\overline{CS}$  goes high, the 16 bits in the Shift register are parallel loaded into a 16-bit latch. The 16 bits in the latch are then decoded and executed.

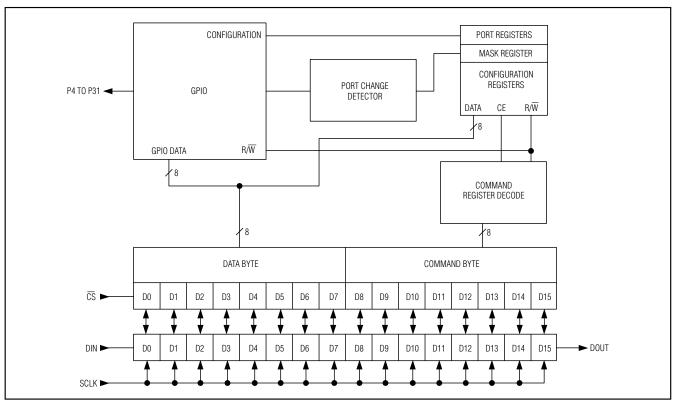


Figure 1. MAX7301 Functional Diagram

The MAX7301 is written to using the following sequence:

- 1) Take SCLK low.
- 2) Take  $\overline{\text{CS}}$  low. This enables the internal 16-bit shift register.
- 3) Clock 16 bits of data into DIN—D15 first, D0 last—observing the setup and hold times (bit D15 is low, indicating a write command).
- 4) Take  $\overline{\text{CS}}$  high (either while SCLK is still high after clocking in the last data bit, or after taking SCLK low).
- 5) Take SCLK low (if not already low).

Figure 4 shows a write operation when 16 bits are transmitted.

It is acceptable to clock more than 16 bits into the MAX7301 between taking  $\overline{\text{CS}}$  low and taking  $\overline{\text{CS}}$  high again. In this case, only the last 16 bits clocked into the MAX7301 are retained.

#### **Reading Device Registers**

Any register data within the MAX7301 may be read by sending a logic high to bit D15. The sequence is:

- 1) Take SCLK low.
- 2) Take  $\overline{\text{CS}}$  low (this enables the internal 16-bit Shift register).
- Clock 16 bits of data into DIN—D15 first to D0 last. D15 is high, indicating a read command and bits D14 through D8 containing the address of the register to be read. Bits D7–D0 contain dummy data, which is discarded.
- 4) Take CS high (either while SCLK is still high after clocking in the last data bit, or after taking SCLK low), positions D7 through D0 in the Shift register are now loaded with the register data addressed by bits D1 through D8.
- 5) Take SCLK low (if not already low).
- 6) Issue another read or write command (which can be a No-Op), and examine the bit stream at DOUT; the second 8 bits are the contents of the register addressed by bits D1 through D8 in step 3.

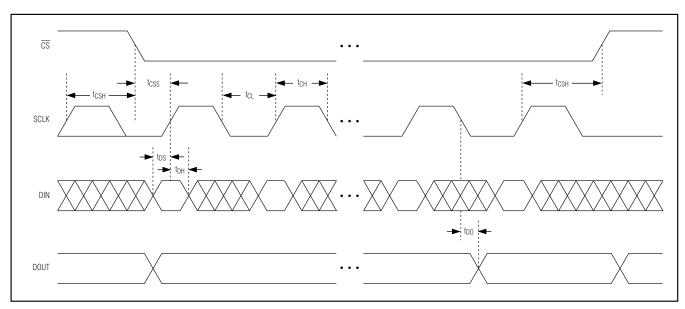


Figure 2. 4-Wire Interface

#### **Initial Power-Up**

On initial power-up, all control registers are reset, and the MAX7301 enters shutdown mode (Table 4).

#### **Transition (Port Data Change) Detection**

Port transition detection allows any combination of the seven ports P24–P30 to be continuously monitored for changes in their logic status (Figure 5). A detected change is flagged on port P31, which is used as an active-high interrupt output (INT). Note that the MAX7301 does not identify which specific port(s) caused the interrupt, but provides an alert that one or more port levels have changed.

The mask register contains 7 mask bits that select which of the seven ports, P24–P30 are to be monitored (Table 8). Set the appropriate mask bit to enable that port for transition detect. Clear the mask bit if transitions on that port are to be ignored. Transition detection works regardless of whether the port being monitored is set to input or output, but generally it is not particularly useful to enable transition detection for outputs.

Port P31 must be configured as an output in order to work as the interrupt output INT when transition detection is used. Port P31 is set as output by writing bit D7 = 0 and bit D6 = 1 to the port configuration register (Table 1).

To use transition detection, first set up the mask register and configure port P31 as an output, as described above. Then enable transition detection by setting the M bit in the configuration register (Table 7). Whenever

the configuration register is written with the M bit set, the MAX7301 updates an internal 7-bit snapshot register, which holds the comparison copy of the logic states of ports P24 through P30. The update action occurs regardless of the previous state of the M bit, so that it is not necessary to clear the M bit and then set it again to update the snapshot register.

When the configuration register is written with the M bit set, transition detection is enabled and remains enabled until either the configuration register is written with the M bit clear, or a transition is detected. The INT output port P31 goes low, if it was not already low.

Once transition detection is enabled, the MAX7301 continuously compares the snapshot register against the changing states of P24 through P31. If a change on any of the monitored ports is detected, even for a short time (like a pulse), INT output port P31 is latched high. The INT output is not cleared if more changes occur or if the data pattern returns to its original snapshot condition. The only way to clear INT is to access (read or write) the transition detection mask register (Table 8).

Transition detection is a one-shot event. When INT has been cleared after responding to a transition event, transition detection is automatically disabled, even though the M bit in the configuration register remains set (unless cleared by the user). Reenable transition detection by writing the configuration register with the M bit set, to take a new snapshot of the seven ports P24 to P30.

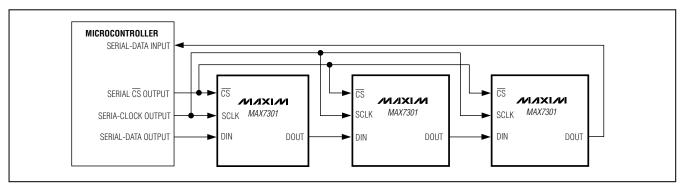


Figure 3. Daisy-Chain Arrangement for Controlling Multiple MAX7301s

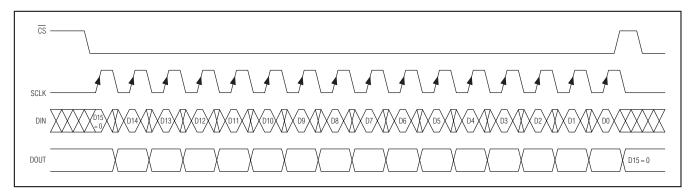


Figure 4. Transmission of a16-Bit Write to the MAX7301

#### External Component RISET

The MAX7301 uses an external resistor, R<sub>ISET</sub>, to set internal biasing. Use a resistor value of 39k $\Omega$ .

### Applications Information

#### **Low-Voltage Operation**

The MAX7301 operates down to 2V supply voltage (although the sourcing and sinking currents are not guaranteed), providing that the MAX7301 is powered up initially to at least 2.5V to trigger the device's internal reset, and also that the serial interface is constrained to 10Mbps.

#### **SPI Routing Considerations**

The MAX7301's SPI interface is guaranteed to operate at 26Mbps on a 2.5V supply, and on a 5V supply typically operates at 50Mbps. This means that transmission line issues should be considered when the interface connections are longer than 100mm, particularly with higher supply voltages. Ringing manifests itself as communication issues, often intermittent, typically due to double clocking due to ringing at the SCLK input. Fit a 1k $\Omega$  to 10k $\Omega$  parallel termination resistor to either GND or V+ at the DIN, SCLK, and  $\overline{\text{CS}}$  input to damp

ringing for moderately long interface runs. Use lineimpedance matching terminations when making connections between boards.

#### **PC Board Layout Considerations**

For the TQFN version, connect the underside exposed pad to GND. Ensure that all the MAX7301 GND connections are used. A ground plane is not necessary, but may be useful to reduce supply impedance if the MAX7301 outputs are to be heavily loaded. Keep the track length from the ISET pin to the RISET resistor as short as possible, and take the GND end of the resistor either to the ground plane or directly to the ground pins.

#### **Power-Supply Considerations**

The MAX7301 operates with power-supply voltages of 2.5V to 5.5V. Bypass the power supply to GND with a 0.047µF capacitor as close to the device as possible. Add a 1µF capacitor if the MAX7301 is far away from the board's input bulk decoupling capacitor.

#### \_Chip Information

TRANSISTOR COUNT: 30,316

PROCESS: CMOS

**Table 3. Register Address Map** 

DEGIGTED			CO	MMANE	ADDRE	ESS			HEX
REGISTER	D15	D14	D13	D12	D11	D10	D9	D8	CODE
No-Op	R/W	0	0	0	0	0	0	0	0x00
Configuration	R/W	0	0	0	0	1	0	0	0x04
Transition Detect Mask	R/W	0	0	0	0	1	1	0	0x06
Factory Reserved. Do not write to this.	R/W	0	0	0	0	1	1	1	0x07
Port Configuration P7, P6, P5, P4	R/W	0	0	0	1	0	0	1	0x09
Port Configuration P11, P10, P9, P8	R/W	0	0	0	1	0	1	0	0x0A
Port Configuration P15, P14, P13, P12	R/W	0	0	0	1	0	1	1	0x0B
Port Configuration P19, P18, P17, P16	R/W	0	0	0	1	1	0	0	0x0C
Port Configuration P23, P22, P21, P20	R/W	0	0	0	1	1	0	1	0x0D
Port Configuration P27, P26, P25, P24	R/W	0	0	0	1	1	1	0	0x0E
Port Configuration P31, P30, P29, P28	R/W	0	0	0	1	1	1	1	0x0F
Port 0 only (virtual port, no action)	R/W	0	1	0	0	0	0	0	0x20
Port 1 only (virtual port, no action)	R/W	0	1	0	0	0	0	1	0x21
Port 2 only (virtual port, no action)	R/W	0	1	0	0	0	1	0	0x22
Port 3 only (virtual port, no action)	R/W	0	1	0	0	0	1	1	0x23
Port 4 only (data bit D0. D7-D1 read as 0)	R/W	0	1	0	0	1	0	0	0x24
Port 5 only (data bit D0. D7–D1 read as 0)	R/W	0	1	0	0	1	0	1	0x25
Port 6 only (data bit D0. D7–D1 read as 0)	R/W	0	1	0	0	1	1	0	0x26
Port 7 only (data bit D0. D7–D1 read as 0)	R/W	0	1	0	0	1	1	1	0x27
Port 8 only (data bit D0. D7-D1 read as 0)	R/W	0	1	0	1	0	0	0	0x28
Port 9 only (data bit D0. D7-D1 read as 0)	R/W	0	1	0	1	0	0	1	0x29
Port 10 only (data bit D0. D7–D1 read as 0)	R/W	0	1	0	1	0	1	0	0x2A
Port 11 only (data bit D0. D7–D1 read as 0)	R/W	0	1	0	1	0	1	1	0x2B
Port 12 only (data bit D0. D7–D1 read as 0)	R/W	0	1	0	1	1	0	0	0x2C
Port 13 only (data bit D0. D7–D1 read as 0)	R/W	0	1	0	1	1	0	1	0x2D
Port 14 only (data bit D0. D7–D1 read as 0)	R/W	0	1	0	1	1	1	0	0x2E
Port 15 only (data bit D0. D7–D1 read as 0)	R/W	0	1	0	1	1	1	1	0x2F
Port 16 only (data bit D0. D7-D1 read as 0)	R/W	0	1	1	0	0	0	0	0x30
Port 17 only (data bit D0. D7-D1 read as 0)	R/W	0	1	1	0	0	0	1	0x31
Port 18 only (data bit D0. D7-D1 read as 0)	R/W	0	1	1	0	0	1	0	0x32
Port 19 only (data bit D0. D7–D1 read as 0)	R/W	0	1	1	0	0	1	1	0x33
Port 20 only (data bit D0. D7–D1 read as 0)	R/W	0	1	1	0	1	0	0	0x34
Port 21 only (data bit D0. D7–D1 read as 0)	R/W	0	1	1	0	1	0	1	0x35
Port 22 only (data bit D0. D7-D1 read as 0)	R/W	0	1	1	0	1	1	0	0x36
Port 23 only (data bit D0. D7–D1 read as 0)	R/W	0	1	1	0	1	1	1	0x37
Port 24 only (data bit D0. D7–D1 read as 0)	R/W	0	1	1	1	0	0	0	0x38
Port 25 only (data bit D0. D7–D1 read as 0)	R/W	0	1	1	1	0	0	1	0x39

01 \_\_\_\_\_\_ 01 \_\_\_\_\_ 01 \_\_\_\_ 01 \_\_\_\_ 01 \_\_\_\_ 01 \_\_\_\_ 01 \_\_\_\_ 01 \_\_\_\_ 01 \_\_\_\_ 01 \_\_\_ 01 \_\_\_ 01 \_\_\_ 01 \_\_\_ 01 \_\_\_ 01

**Table 3. Register Address Map (continued)** 

DEGLOTED			СО	MMAND	ADDRE	ESS			HEX
REGISTER	D15	D14	D13	D12	D11	D10	D9	D8	CODE
Port 26 only (data bit D0. D7-D1 read as 0)	R/W	0	1	1	1	0	1	0	0x3A
Port 27 only (data bit D0. D7–D1 read as 0)	R/W	0	1	1	1	0	1	1	0x3B
Port 28 only (data bit D0. D7–D1 read as 0)	R/W	0	1	1	1	1	0	0	0x3C
Port 29 only (data bit D0. D7-D1 read as 0)	R/W	0	1	1	1	1	0	1	0x3D
Port 30 only (data bit D0. D7–D1 read as 0)	R/W	0	1	1	1	1	1	0	0x3E
Port 31 only (data bit D0. D7–D1 read as 0)	R/W	0	1	1	1	1	1	1	0x3F
4 ports 4-7 (data bits D0-D3. D4-D7 read as 0)	R/W	1	0	0	0	0	0	0	0x40
5 ports 4-8 (data bits D0-D4. D5-D7 read as 0)	R/W	1	0	0	0	0	0	1	0x41
6 ports 4–9 (data bits D0–D5. D6–D7 read as 0)	R/W	1	0	0	0	0	1	0	0x42
7 ports 4-10 (data bits D0-D6. D7 reads as 0)	R/W	1	0	0	0	0	1	1	0x43
8 ports 4–11 (data bits D0–D7)	R/W	1	0	0	0	1	0	0	0x44
8 ports 5–12 (data bits D0–D7)	R/W	1	0	0	0	1	0	1	0x45
8 ports 6–13 (data bits D0–D7)	R/W	1	0	0	0	1	1	0	0x46
8 ports 7–14 (data bits D0–D7)	R/W	1	0	0	0	1	1	1	0x47
8 ports 8–15 (data bits D0–D7)	R/W	1	0	0	1	0	0	0	0x48
8 ports 9–16 (data bits D0–D7)	R/W	1	0	0	1	0	0	1	0x49
8 ports 10-17 (data bits D0-D7)	R/W	1	0	0	1	0	1	0	0x4A
8 ports 11–18 (data bits D0–D7)	R/W	1	0	0	1	0	1	1	0x4B
8 ports 12–19 (data bits D0–D7)	R/W	1	0	0	1	1	0	0	0x4C
8 ports 13-20 (data bits D0-D7)	R/W	1	0	0	1	1	0	1	0x4D
8 ports 14-21 (data bits D0-D7)	R/W	1	0	0	1	1	1	0	0x4E
8 ports 15-22 (data bits D0-D7)	R/W	1	0	0	1	1	1	1	0x4F
8 ports 16-23 (data bits D0-D7)	R/W	1	0	1	0	0	0	0	0x50
8 ports 17–24 (data bits D0–D7)	R/W	1	0	1	0	0	0	1	0x51
8 ports 18-25 (data bits D0-D7)	R/W	1	0	1	0	0	1	0	0x52
8 ports 19-26 (data bits D0-D7)	R/W	1	0	1	0	0	1	1	0x53
8 ports 20–27 (data bits D0–D7)	R/W	1	0	1	0	1	0	0	0x54
8 ports 21–28 (data bits D0–D7)	R/W	1	0	1	0	1	0	1	0x55
8 ports 22–29 (data bits D0–D7)	R/W	1	0	1	0	1	1	0	0x56
8 ports 23–30 (data bits D0–D7)	R/W	1	0	1	0	1	1	1	0x57
8 ports 24–31 (data bits D0–D7)	R/W	1	0	1	1	0	0	0	0x58
7 ports 25-31 (data bits D0-D6. D7 reads as 0)	R/W	1	0	1	1	0	0	1	0x59
6 ports 26-31 (data bits D0-D5. D6-D7 read as 0)	R/W	1	0	1	1	0	1	0	0x5A
5 ports 27-31 (data bits D0-D4. D5-D7 read as 0)	R/W	1	0	1	1	0	1	1	0x5B
4 ports 28-31 (data bits D0-D3. D4-D7 read as 0)	R/W	1	0	1	1	1	0	0	0x5C
3 ports 29-31 (data bits D0-D2. D3-D7 read as 0)	R/W	1	0	1	1	1	0	1	0x5D
2 ports 30-31 (data bits D0-D1. D2-D7 read as 0)	R/W	1	0	1	1	1	1	0	0x5E
1 port 31 only (data bit D0. D1-D7 read as 0)	R/W	1	0	1	1	1	1	1	0x5F

Note: Unused bits read as 0.



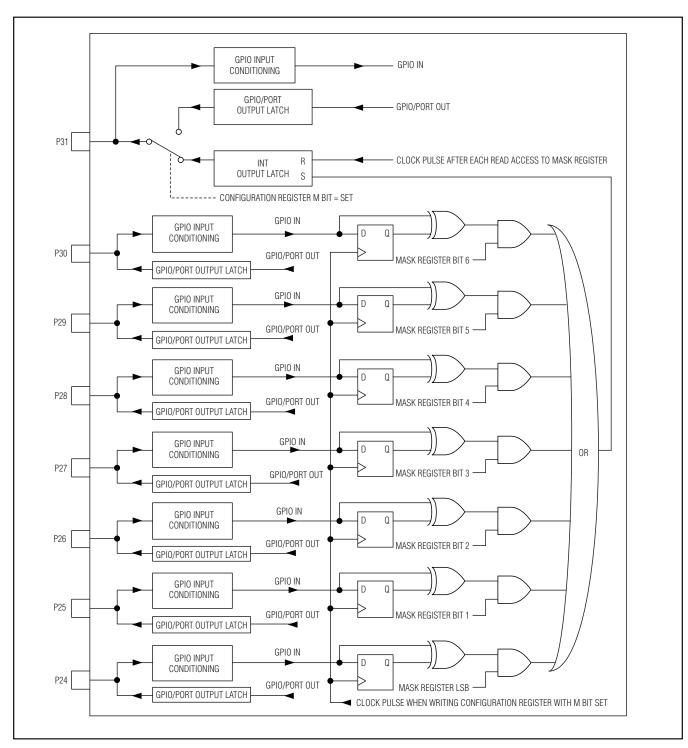


Figure 5. Maskable GPIO Ports P24 Through P31

**Table 4. Power-Up Configuration** 

REGISTER	DOWED UP CONDITION	ADDRESS			RE	GISTI	R DA	TA		
FUNCTION	POWER-UP CONDITION	CODE (HEX)	D7	D6	D5	D4	D3	D2	D1	D0
Port Register Bits 4 to 31	GPIO Output Low	0x24 to 0x3F	Χ	Х	Х	Х	Х	Х	Х	0
Configuration Register	Shutdown Enabled Transition Detection Disabled	0x04	0	0	Х	Х	Х	Х	Х	0
Input Mask Register	All Clear (Masked Off)	0x06	Х	0	0	0	0	0	0	0
Port Configuration	P7, P6, P5, P4: GPIO Inputs Without Pullup	0x09	1	0	1	0	1	0	1	0
Port Configuration	P11, P10, P9, P8: GPIO Inputs Without Pullup	0x0A	1	0	1	0	1	0	1	0
Port Configuration	P15, P14, P13, P12: GPIO Inputs Without Pullup	0x0B	1	0	1	0	1	0	1	0
Port Configuration	P19, P18, P17, P16: GPIO Inputs Without Pullup	0x0C	1	0	1	0	1	0	1	0
Port Configuration	P23, P22, P21, P20: GPIO Inputs Without Pullup	0x0D	1	0	1	0	1	0	1	0
Port Configuration	P27, P26, P25, P24: GPIO Inputs Without Pullup	0x0E	1	0	1	0	1	0	1	0
Port Configuration	P31, P30, P29, P28: GPIO Inputs Without Pullup	0x0F	1	0	1	0	1	0	1	0

X = Unused bits; if read, zero results.

### **Table 5. Configuration Register Format**

FUNCTION	ADDRESS CODE	REGISTER DATA								
	(HEX)	D7	D6	D5	D4	D3	D2	D1	D0	
Configuration Register	0x04	М	0	X	Χ	X	X	X	S	

### Table 6. Shutdown Control (S Data Bit D0) Format

FUNCTION	ADDRESS CODE	REGISTER DATA								
FUNCTION	(HEX)	D7	D6	D5	D4	D3	D2	D1	D0	
Shutdown	0x04	М	0	Χ	Χ	Χ	Χ	Χ	0	
Normal Operation	0x04	М	0	Χ	Χ	Χ	Χ	Χ	1	



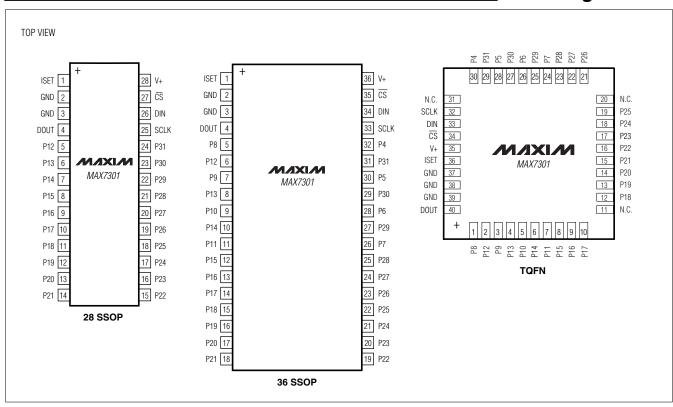
### Table 7. Transition Detection Control (M Data Bit D7) Format

FUNCTION	ADDRESS CODE	REGISTER DATA								
FUNCTION	(HEX)	D7	D6	D5	D4	D3	D2	D1	D0	
Disabled	0x04	0	0	Χ	Χ	Χ	Χ	Χ	S	
Enabled	0x04	1	0	Χ	Χ	Χ	Χ	Χ	S	

### **Table 8. Transition Detection Mask Register**

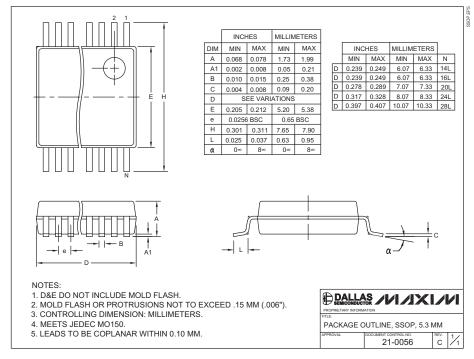
FUNCTION	REGISTER	READ/	READ/ REGISTER DATA									
FUNCTION	ADDRESS (HEX)	WRITE	D7	D6	D5	D4	D3	D2	D1	D0		
Mask	0,,00	Read	0	Port 30	Port 29	Port 28	Port 27	Port 26	Port 25	Port 24		
Register	0x06	Write	Unchanged	mask								

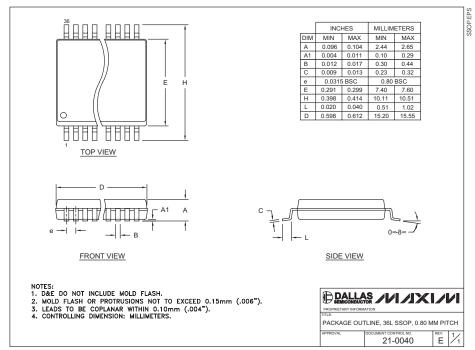
### **Pin Configurations**



#### Package Information

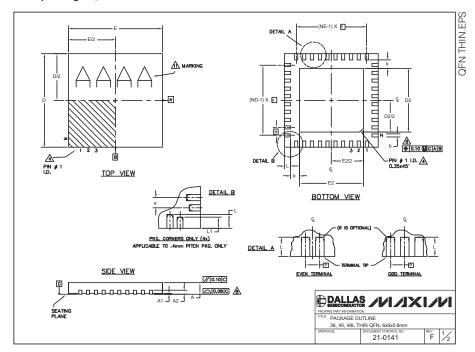
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <a href="https://www.maxim-ic.com/packages">www.maxim-ic.com/packages</a>.)





#### Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



			C	NOMINC	DIMENS	IONS				
PKG.	₩G. 36L 6x6			40L 6x6			48L 6x6			
SYMBOL	MIN.	NOM.	MAX.	MIN.	NOM.	WAX.	MIN. NOM.			
A	0.70	0.75	0.80	0.70	0.75	0.60	0.70	0.75	0.8	
A1	0	0.02	0.05	0	0.02	0.05	٥	-	0.0	
A2		0.20 REF			0.20 REF		0.20 REF.			
ь	0.20	0.25	D.3D	0.20	0.25	0.30	0.15	0.20	0.2	
D	5.90	6.00	6.10	5.90	6.00	6.10	5.90	6.00	6.10	
E	5.90	6.00	6.10	5.90	6.00	6.10	5.90	5.00	6.1	
e		0.50 BSC		0.50 BSC.			0.40 BSC.			
k	0.25	-	-	0.25	_	-	0.25	0.35	0.4	
L	0.45	0.55	D.65	0.30	0.40	0.50	0,40	0.50	0.6	
L1	-	-	-	-	-	-	0.30	0.40	0.5	
N		36		40			48			
ND	9			10			12			
NE	9			10			12			
JEDEC		WJJD-1		WJJD-2			-			

	DOWN						
PKG.		D2			BONDS		
CODES	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
T3666-2	3,60	3,70	3,80	3,60	3,70	3.80	YES
T3666-3	3,60	3,70	3.80	3.60	3,70	3.80	NO
T3666N-1	3.60	3.70	3.80	3.60	3.70	3.80	NO
T4066-2	4.00	4.10	4.20	4.00	4.10	4.20	YES
T4066-3	4.00	4.10	4.20	4.00	4.10	4.20	YES
T4066-4	4.00	4.10	4.20	4.00	4.10	4.20	NO
T4066-5	4.00	4,10	4.20	4.00	4,10	4.20	NO
T4866-1	4.20	4.30	4.40	4.20	4.30	4.40	YES

- DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994 ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES. N IS THE TOTAL NUMBER OF TERMINALS.

ATHE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER AND EAR OPTIONAL BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.

⚠DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.

FROM TERMINAL TIP.

ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.

DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.

COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.

9. DRAWING CONFORMS TO JEDEC MO220, EXCEPT FOR 0.4mm LEAD PITCH PACKAGE T4866-1

10. WARPAGE SHALL NOT EXCEED 0.10 mm.

12. NUMBER OF LEADS SHOWN FOR REFERENCE ONLY.

DALLAS /VI/XI/VI ETARY INFORMATION PACKAGE OUTLINE 36, 40, 48L THIN QFN, 6x6x0.8mr F 2/2

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